

# Development of NTD Ge Sensors for Superconducting Bolometer

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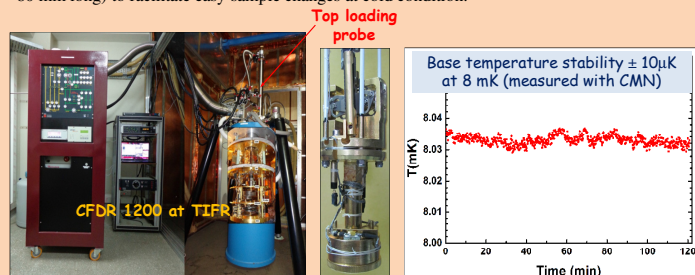
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## Introduction

- Prototype development of superconducting Tin cryogenic bolometer (**TIN.TIN : The India-based TIN Detector**) to search for  $0\nu\beta\beta$  in  $^{124}\text{Sn}$  at the upcoming India-based Neutrino Observatory has been initiated [1].
- Development of Neutron Transmutation Doped Ge sensors for low temperature (mK) thermometry [2] : indigenous effort to fabricate NTD Ge sensors in India
- **Characterization of sensors at T < 300 mK**
  - Optimization of electrical contacts
  - Verification of temperature dependence of R (Mott's law)

## The India-based TIN Detector (TIN.TIN)

- Sn becomes superconducting below  $T_c \sim 3.7$  K and can be made into a bolometric detector ( $T < 100$  mK) with excellent energy resolution.
- $^{124}\text{Sn} \rightarrow ^{124}\text{Te}^+$ ,  $Q_{\beta\beta} = 2292.64 \pm 0.39$  keV, Natural Isotopic Abundance 5.79 %
- A cryogen-free dilution refrigerator (CFDR-1200, Leiden make) installed at TIFR [3]. It has a large sample space and an additional option of a top loading probe (sample space  $\sim 40$  mm dia, 80 mm long) to facilitate easy sample changes at cold condition.



- Minimum temperature without probe  $\sim 8$  mK, with probe  $\sim 12$  mK
- Cooling power 1.4 mW @ 120 mK with about 50 lit. of  $^3\text{He}$
- Provision to mount electronics at 40 K stage

## Fabrication of NTD Ge

- Device grade  $\langle 100 \rangle$  Ge samples (1 mm thick) are irradiated with thermal neutron fluence of  $\sim (1.8 - 4.6) \times 10^{18}$  n/cm<sup>2</sup> at Dhruva Reactor, BARC, Mumbai, India [4].
  - Typical sample size 10 mm x 30 mm, wrapped in aluminum/quartz
  - A few micron surface layer etched away to remove radioactive impurities
- Irradiated samples vacuum annealed at 600 °C for  $\sim 2$  h to cure fast neutron induced defects.
- Carrier concentration estimated using Hall effect measurements at 77 K [5].

Table 1: Thermal neutron fluence and carrier concentration of NTD Ge samples

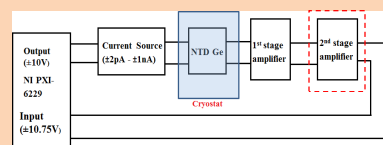
NTD Ge Sample	Thermal neutron fluence (n/cm <sup>2</sup> )	Carrier Conc. (/cm <sup>3</sup> )	
		n-flux	Hall effect
D	$4.57 \times 10^{18}$	$1.11 \times 10^{17}$	$1.11 \times 10^{17}$
G	$3.57 \times 10^{18}$	$8.68 \times 10^{16}$	-
F	$3.52 \times 10^{18}$	$8.55 \times 10^{16}$	-
E	$2.11 \times 10^{18}$	$5.13 \times 10^{16}$	$4.45 \times 10^{16}$
H	$1.8 \times 10^{18}$	$4.37 \times 10^{16}$	$4.17 \times 10^{16}$

## Sensor Test Setup and Readout electronics

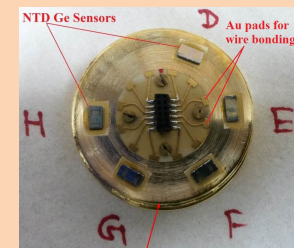
### Electrical contacts for readout:

- $\sim 100$  nm Au-Ge deposition by sputtering
- Rapid Thermally Annealed at 400 °C for 2 min.
- Electrical connections made by Al/Au wire bonding.

### Block Diagram of readout electronics



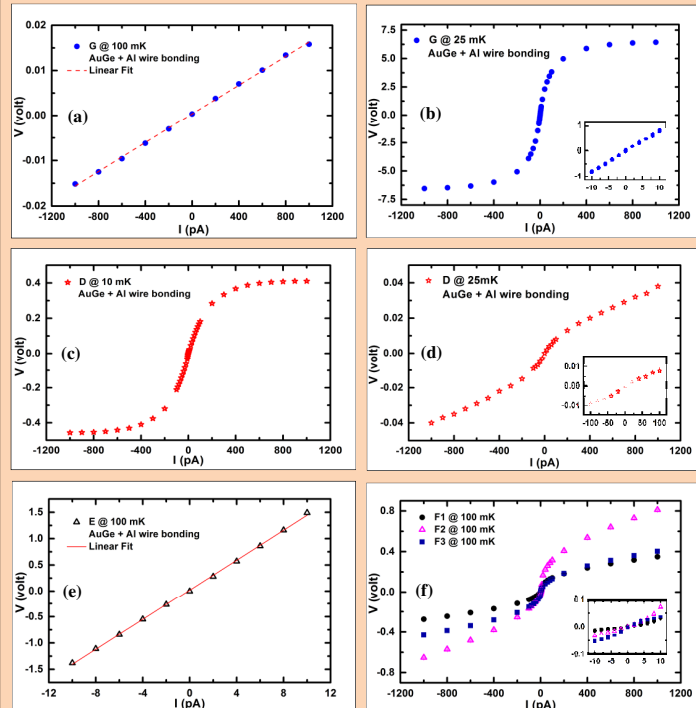
- Low noise pA Current source : CSE09NV, range  $\pm 1$  nA, Resolution 2 pA (RDM apps make).
- Low noise Voltage amplifier: INA 116, Gain 1 - 1000.
- DAQ developed with NI PXI 6229 using Labview signal express.



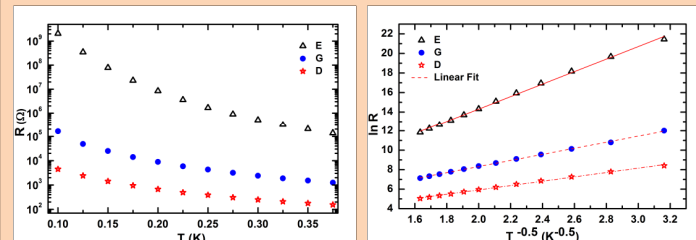
## Resistance Measurements at T ≤ 100 mK

### V-I measurements performed to check the Ohmic nature of the metal semiconductor contact

- Most of the samples showed good Ohmic behaviour at 100 mK, but at lower T (10 - 25 mK) Schottky barrier like nonlinearity is seen (panels a - e, amplifier gain  $\sim 100$ )
  - Observed saturation could also be due to self heating at high current. Therefore R is extracted from slope near the origin.
  - One of the samples did not show good Ohmic contact even at 100 mK. Different metal wires Al, Au etc. gave similar results (shown in panel f).
- F1 : 100 nm AuGe pad and Al wire, F2 : 100 nm AuGe + 100 nm Au pad and Al wire, F3 : 100 nm AuGe + 100 nm Au pad and Au wire.



For NTD Ge sensor temperature dependence of R is given by [6] :  $R = R_0 \exp[\frac{E_0}{T}]^\alpha$   
 $R_0$  depends on intrinsic properties of Ge,  $T_0$  depends on the doping level and constant  $\alpha \sim 0.5$  [7]



Sample	Thermal neutron fluence (n/cm <sup>2</sup> )	$T_0$ (K)	$R_0$ (Ω)
D	$4.57 \times 10^{18}$	$4.9 \pm 0.2$	$4.3 \pm 0.3$
G	$3.57 \times 10^{18}$	$9.8 \pm 0.2$	$7.9 \pm 0.5$
E	$2.11 \times 10^{18}$	$41 \pm 1$	$4.5 \pm 0.9$

In R varies linearly with  $T^{-0.5}$

- Even though the sensors are of very similar geometry, fitted values of  $R_0$  are different.
- Similar behavior reported in Ref. [8]. It is suggested that residual stress, unannealed radiation damage and dislocations may cause this variation at very low temperatures.

## Conclusion & Future Outlook

- NTD Ge sensors have been fabricated, for the first time in India, with high  $dR/dT \sim 100$  MΩ/mK.
- Measurements in 100 - 350 mK range indicate that for fabricated sensors  $\ln R \propto T^{-0.5}$
- Improvements in design of electrical contacts are in progress.
- Optimization of neutron dose required for large scale production.

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